

EMI Filter & ESD Protection for Down Stream **USB** Ports

#### **PRODUCTION DATA SHEET**

#### DESCRIPTION

The LX7201 is an integrated downstream port. The  $15K\Omega$  pull-down resistors identify the in USB hubs, peripherals and portable line as a downstream connection.

SF

The 47 pF capacitor completes the Universal Serial Bus (USB) line high frequency filter and controls the termination device with an EMI filter edge rate of the USB signals. The and ESD protection diodes. This LX7201 protects both D+ and D- data device offers a cost effective and lines and the voltage bus from ESD. compact solution for one USB The TVS protection diodes exceed the USB requirements of IEC61000-4-2, level 4, specification requires line termination 15kV (air discharge) and 8kV (contact resistors on both the D+ and D- lines. discharge). The integrated configuration These resistors ensure signal integrity of the LX7201 minimizes board space by matching the cable impedance to and allows for ideal placement near the that of the differential driver. The connector. The LX7201 is ideal for use appliances.

**Tape & Reel Quantity** 

3K (7inches)

(Reel Size)

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

Plastic

LX7201-15ISF

LX7201-22ISF

6-Pin SOT23

PACKAGE ORDER INFO

Note: Append the letter "T" to the part number

For Tape & Reel Ordering

Package

Marking

2011

2012

#### **KEY FEATURES**

- **Bi-directional EMI/RFI Low-Pass** Filter
- Line Termination with Integrated ESD Protection
- Low TVS Operating Voltage (5.25V)
- Low Leakage Current
- Integrated Single Die Construction
- Available With 15 or 22Ω Series Resistance
- Crosses from Semtech STF201

#### APPLICATIONS

- USB 1.1 and USB 2.0 Full
- Speed Compliant Peripherals
- Printers
- Monitors
- Servers. Desktops and Notebook Computers
- **Digital Cameras**

#### BENEFITS

- Filter response characterized up to 6 GHz
- <2dB insertion loss in the pass hand
- >20dB attenuation in the 800-900 MHz range
- >12dB attenuation in the WLAN frequencies of 2.4GHz and 5.0-6.0 GHz



 $T_J (^{\circ}C)$ 

-40 to 125

-40 to 125



GND

D<sub>OUT</sub>

D<sub>OUT</sub>

#### EMI Filter & ESD Protection for Down Stream USB Ports

**PRODUCTION DATA SHEET** 

Steady State Power	
ESD Air Discharge per IEC61000-4-2	
ESD Contact Discharge per IEC61000-4-2	
Lead Soldering Temperature (10 Seconds)	
Operating Temperature	40°C to +125°C
Storage Temperature Range	55°C to +150°C

RATINGS

ABSOLUTE MAXIMUM

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to Ground. Currents are positive into, negative out of specified terminal.

THERMAL DATA

100mW 16kV 10kV	V <sub>BUS</sub> 1	6
260°C to +125°C	D <sub>IN</sub> 2	5
10 +130°C		1
es are with ninal.	SF PACKAGE (Top View)	
<u> </u>		
62 °C/W		
96 °C/W		

PACKAGE PIN OUT

**SF** Plastic SOT23 6-Pin THERMAL RESISTANCE-JUNCTION TO CASE,  $\theta_{JC}$ 

THERMAL RESISTANCE-JUNCTION TO CASE,  $\theta_{JA}$ 

Junction Temperature Calculation:  $T_J = T_A + (P_D \times \theta_{JA})$ .

The  $\theta_{JA}$  numbers are guidelines for the thermal performance of the device/pc-board system. All of the above assume no ambient airflow.

FUNCTIONAL PIN DESCRIPTION				
Name Description				
VBUS	Bus Voltage			
DIN	Data In			
GND	Ground			
DOUT	Data Out			
	Name VBUS DIN GND DOUT			

#### ELECTRICAL CHARACTERISTICS

Unless otherwise specified, the following specifications apply over the operating ambient temperature  $-40^{\circ}C \le T_A \le +125^{\circ}C$  except where otherwise noted.

Parameter	Symbol Test Conditions		LX7201-xx			Unite
Falameter	Symbol	Test conditions	Min	Тур	Max	Units
Stand-Off Voltage	VR <sub>WM</sub>				5.25	V
Breakdown Voltage	V <sub>BR</sub>	IR = 1mA	6			V
Leakage Current	I <sub>R</sub>	VRWM = 5.25V, T = 25°C			1	μA
Series Resistance (-15)	Rs	Each Line	13.5	15	16.5	Ω
Series Resistance (-22)	Rs	Each Line	19.8	22	24.2	Ω
Temperature Coefficient of R <sub>S</sub>	T <sub>COEFF</sub>	Each Line		200		ppm
Pull Down Resistance	R <sub>PD</sub>	Each Line	13.5	15	16.5	KΩ
Capacitor	С	Each Line		47		pF
Total Capacitance	Стот	Between I/O Pins and Ground, Each Device VR = 0V, f = 1MHz	54	60	66	pF



EMI Filter & ESD Protection for Down Stream USB Ports PRODUCTION DATA SHEET

### **APPLICATION CIRCUITS**



#### APPLICATION INFORMATION

The LX7201 meets the requirements of the USB v1.1 and USB 2.0 Full Speed specification for device termination, EMI filtering and ESD protection. The R<sub>s</sub> resistor provides the proper signal termination; the 47pF capacitor controls the signal rise and fall slew; the TVS diodes protect the IC from ESD damage; and the total capacitance and resistance creates a low pass filter eliminating the high frequency energy from the circuit.

#### Device Connection:

- Voltage Supply (V<sub>BUS</sub>) is connected to Pin 1
- Ground is connected to Pin 6
- D+ from the connector is routed to Pin 2 and out of Pin 5.
- D- from the connector is routed to Pin 3 and out of Pin 4.

#### ELECTROMAGNETIC EMISSION AND SUSCEPTABILITY

FCC Part 15 sets limits for maximum allowable EM emission and susceptibility. There are two types of emissions. Conducted emissions with frequency of emission of 0.45 to 30 MHz and Radiated emissions with frequency of emission of 30 MHz to 40 GHz. All digital computing devices including the peripheral devices must comply. Examples of peripheral devices include terminals, printers, external floppy disk drives and other data storage devices, video monitors,

keyboards, control cards, interface boards, external memory expansion cards and other input/output devices that may or may not contain digital circuitry. LX7201 is optimized to minimize the radiated EMI which is the primary concern in devices using USB. Refer to the typical filter response curve for the attenuation characteristics of LX7201 over the frequency range of 30KHz to 6GHz.



EMI Filter & ESD Protection for Down Stream USB Ports PRODUCTION DATA SHEET





EMI Filter & ESD Protection for Down Stream USB Ports PRODUCTION DATA SHEET

## PACKAGE DIMENSIONS

### SF

## 6-Pin SOT-23 Package



	MILLIMETERS		INCHES		
Dim	MIN	MAX	MIN	MAX	
А	0.90	1.30	0.035	0.051	
A1	0.90	1.45	0.035	0.057	
В	0.25	0.50	0.010	<mark>0</mark> .020	
С	0.09	0.20	0.004	0.008	
D	2.80	3.10	0.110	0.122	
Е	1.50	1.75	0.059	0.069	
F	0.95 BSC 1.90 BSC		0.038 BSC		
G			0 BSC 0.075 BSC		
Н	2.60	3.00	0.102	0.118	
-	0.35	0.55	0.014	0.022	
J	0.00	0.15	0.000	0.006	
K	10° MAX		10°	MAX	

#### Note:

1. Dimensions do not include mold flash or protrusions; these shall not exceed 0.155mm(.006") on any side. Lead dimension shall not include solder coverage.

## **Recommended Footprint**



	MILLIMETERS		INCHES		
Dim	MIN	MAX	MIN	MAX	
С	-	2.40	-	0.094	
D	-	1.90	-	0.074	
E	-	0.95	-	0.037	
Х	-	0.70	-	0.028	
Y	-	1.00	-	0.039	

Copyright © 2002 Rev. 1.0e, 2007-04-11



EMI Filter & ESD Protection for Down Stream USB Ports PRODUCTION DATA SHEET

NOTES

PRODUCTION DATA – Information contained in this document is proprietary to Microsemi and is current as of publication date. This document may not be modified in any way without the express written consent of Microsemi. Product processing does not necessarily include testing of all parameters. Microsemi reserves the right to change the configuration and performance of the product and to discontinue product at any time.